

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
20V	32mΩ@4.5V	2.1A
	43mΩ@2.5V	

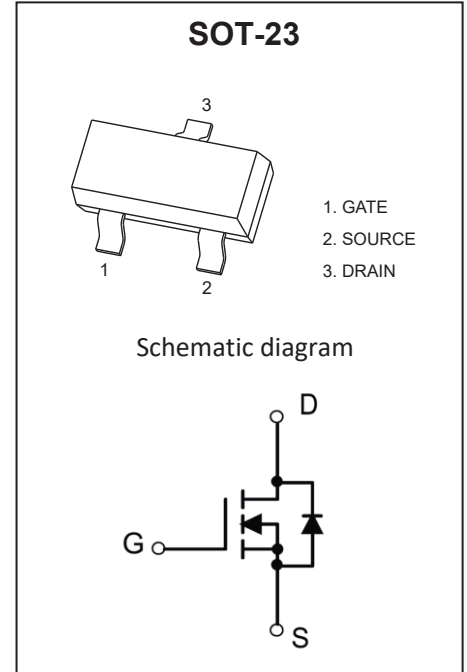
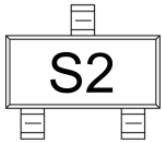
Feature

- TrenchFET Power MOSFET
- Excellent $R_{DS(on)}$ and Low Gate Charge

Application

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch

MARKING:



ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	±8	V
Continuous Drain Current ^{1,5}	I_D	2.1	A
Plused Drain Current ²	I_{DM}	10	A
Power Dissipation ^{4,5}	P_D	1.4	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	89	°C/W
Junction and Storage Temperature Range	T_{STG}	-55~ +150	°C

MOSFET ELECTRICAL CHARACTERISTICS(T_a=25°C unless otherwise noted)

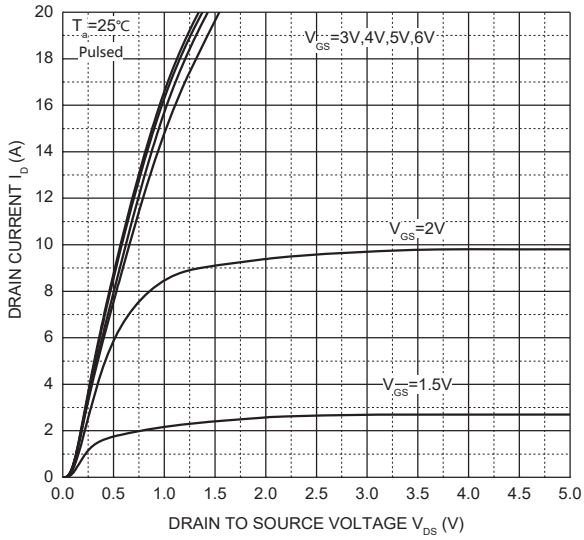
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250μA	20			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =20V, V _{GS} = 0V			1	μA
Gate-body leakage current	I _{GSS}	V _{GS} =±8V, V _{DS} = 0V			±0.1	μA
Gate threshold voltage ³	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.65	0.95	1.2	V
Drain-source on-resistance ³	R _{DS(on)}	V _{GS} =4.5V, I _D =3.6A		32	42	mΩ
		V _{GS} =2.5V, I _D =3.1A		43	65	
Forward tranconductance ³	g _{FS}	V _{DS} =5V, I _D =3.6A	8			S
Dynamic characteristics						
Input Capacitance	C _{iss}	V _{DS} =10V, V _{GS} =0V, f=1MHz		260		pF
Output Capacitance	C _{oss}			48		pF
Reverse Transfer Capacitance	C _{rss}			27		pF
Total gate charge	Q _g	V _{DS} =10V, V _{GS} =4.5V, I _D =3.0A		2.9	5	nC
Gate-source charge	Q _{gs}			0.4		nC
Gate-drain charge	Q _{gd}			0.6		nC
Switching Characteristics						
Turn-on delay time	t _{d(on)}	V _{DD} =10V, R _L =3.3Ω, V _{GEN} =4.5V, R _g =6Ω		2.5		ns
Turn-on rise time	t _r			3.2		ns
Turn-off delay time	t _{d(off)}			21		ns
Turn-off fall time	t _f			3		ns
Source-Drain Diode characteristics						
Diode Forward voltage ³	V _{DS}	V _{GS} =0V, I _S =0.94A		0.7	1.2	V

Notes :

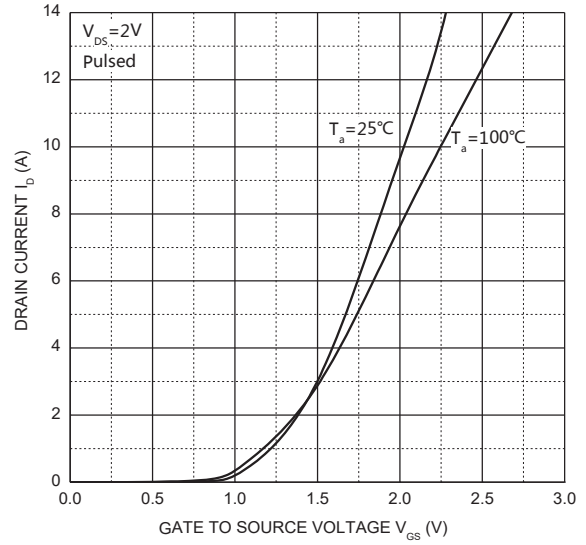
- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width ≤ 10μs, duty cycle ≤ 1%.
- 3.Pulse Test : Pulse Width ≤ 300μs, duty cycle ≤ 2%.
- 4.The power dissipation P_D is limited by T_{J(MAX)} = 150°C.
- 5.Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.

Typical Electrical and Thermal Characteristics

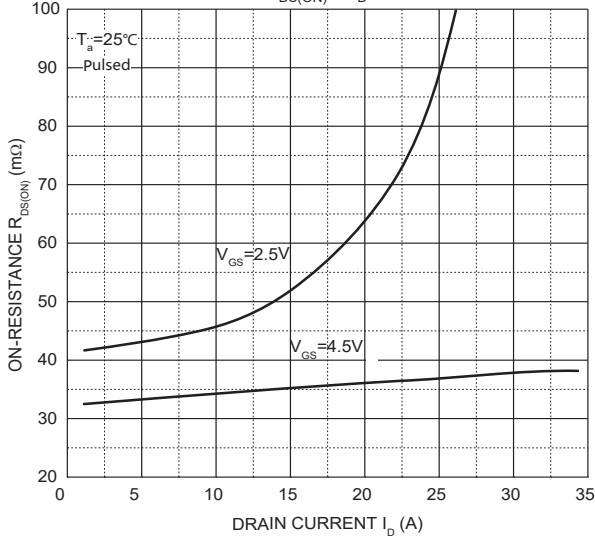
Output Characteristics



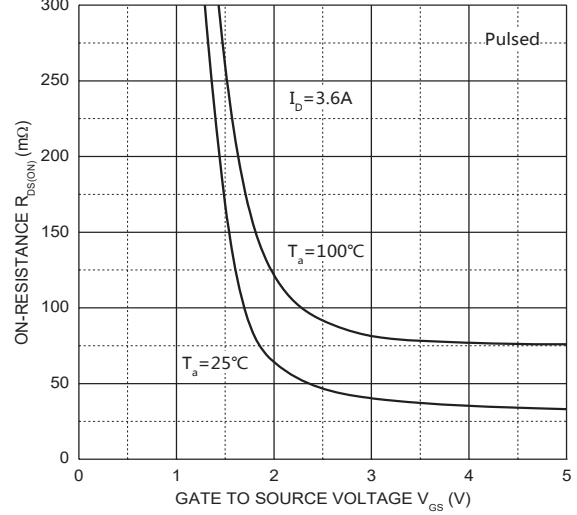
Transfer Characteristics



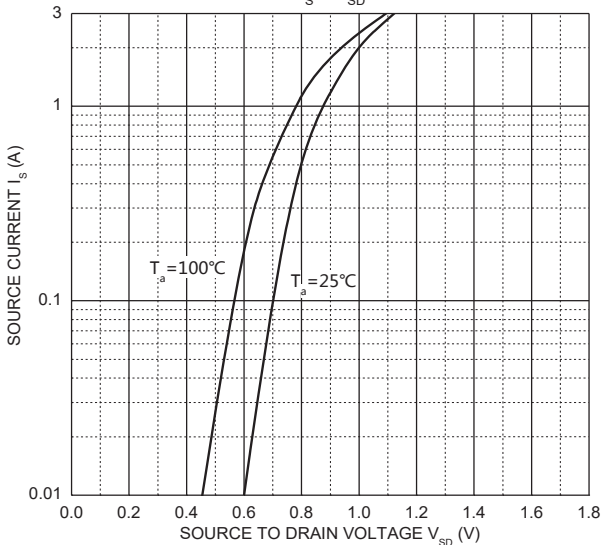
$R_{DS(ON)} - I_D$



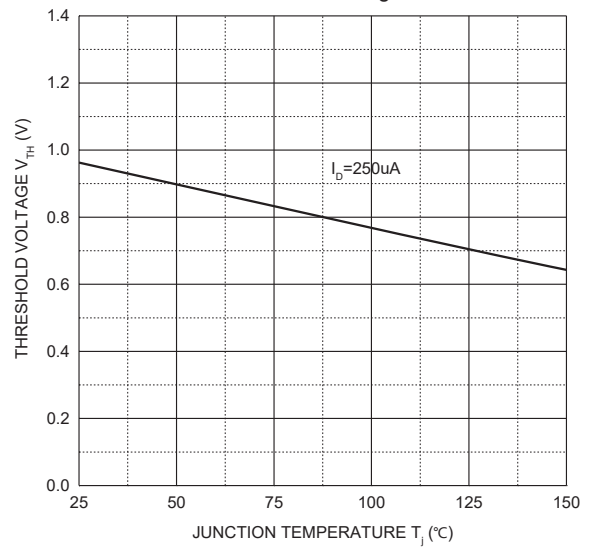
$R_{DS(ON)} - V_{GS}$

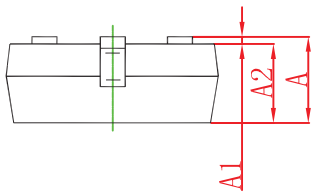
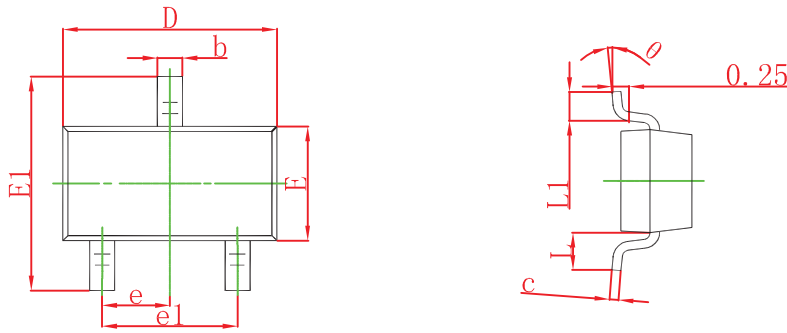


$I_S - V_{SD}$



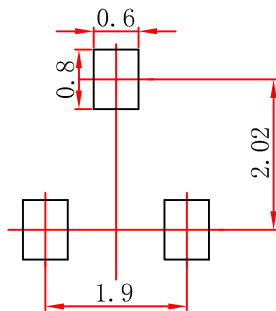
Threshold Voltage





Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.